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## Thank you to all participants, authors and reviewers of Key Engineering Materials VI

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15 Agustus 2016 pukul 13.50

Kepada: Yustiasih Purwaningrum <yustiasih.purwaningrum@uii.ac.id>



Dear Yustiasih Purwaningrum,

We would like to thank you all: participants, authors and reviewers for the great work you did to help produce this new book.

[Key Engineering Materials VI](#)

<http://www.scientific.net/KEM.705>

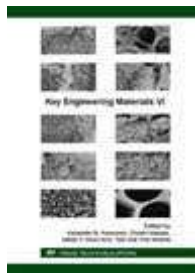
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### Key Engineering Materials VI

The purpose of this collection which was prepared by results of the 6th International Conference on Key Engineering Materials (ICKEM 2016) is to offer the scientists and engineers of results of current research in area of key engineering materials.

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